

C3D1P7060Q

Silicon Carbide Schottky Diode

Z-REC™ RECTIFIER

$$V_{RRM} = 600 \text{ V}$$

$$I_F (T_c=135^\circ\text{C}) = 3 \text{ A}$$

$$Q_c = 4.4 \text{ nC}$$

Features

- 600-Volt Schottky Rectifier
- Optimized for PFC Boost Diode Application
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

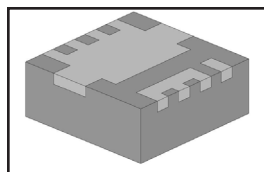
Benefits

- Small compact surface mount package
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switch Mode Power Supplies
- LED Lighting

Package



PowerQFN 3.3x3.3



Part Number	Package	Marking
C3D1P7060Q	QFN 3.3	C3D1P7060

Maximum Ratings ($T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	600	V		
V_{RSM}	Surge Peak Reverse Voltage	600	V		
V_{DC}	DC Blocking Voltage	600	V		
I_F	Continuous Forward Current	7 3 1.7	A	$T_c=25^\circ\text{C}$ $T_c=135^\circ\text{C}$ $T_c=150^\circ\text{C}$	See Fig 3
I_{FRM}	Repetitive Peak Forward Surge Current	7 4.5	A	$T_c=25^\circ\text{C}$, $t_p=10$ ms, Half Sine pulse $T_c=110^\circ\text{C}$, $t_p=10$ ms, Half Sine pulse	
I_{FSM}	Non-Repetitive Peak Forward Surge Current	15 12	A	$T_c=25^\circ\text{C}$, $t_p=10$ ms, Half Sine pulse $T_c=110^\circ\text{C}$, $t_p=10$ ms, Half Sine pulse	
P_{tot}	Power Dissipation	35.5 13	W	$T_c=25^\circ\text{C}$ $T_c=110^\circ\text{C}$	
T_J, T_{stg}	Operating Junction and Storage Temperature	-55 to +160	$^\circ\text{C}$		
T_c	Maximum Case Temperature	150	$^\circ\text{C}$		

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.5 1.8	1.7 2.4	V	$I_F = 1.7\text{ A}$ $T_C = 25^\circ\text{C}$ $I_F = 1.7\text{ A}$ $T_C = 150^\circ\text{C}$	
I_R	Reverse Current	10 20	50 100	μA	$V_R = 600\text{ V}$ $T_C = 25^\circ\text{C}$ $V_R = 600\text{ V}$ $T_C = 150^\circ\text{C}$	
Q_C	Total Capacitive Charge	4.4		nC	$V_R = 400\text{ V}$, $I_F = 1.7\text{ A}$ $di/dt = 500\text{ A}/\mu\text{s}$ $T_C = 25^\circ\text{C}$	
C	Total Capacitance	100 7 6		pF	$V_R = 0\text{ V}$, $T_C = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 200\text{ V}$, $T_C = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 400\text{ V}$, $T_C = 25^\circ\text{C}$, $f = 1\text{ MHz}$	

Note:

1. zThis is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Typ.	Unit
$R_{\theta JC}$	Package Thermal Resistance from Junction to Case	3.8	$^\circ\text{C}/\text{W}$

Typical Performance

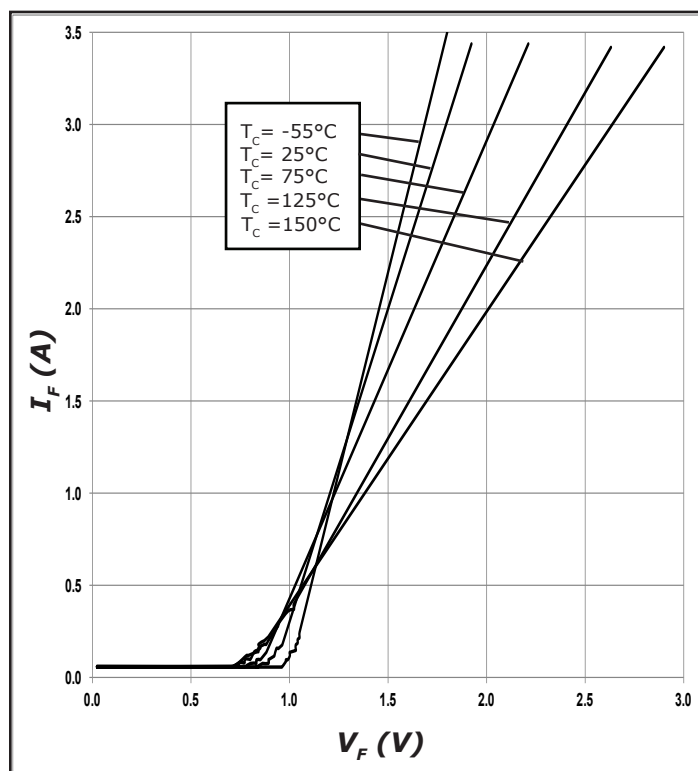


Figure 1. Forward Characteristics

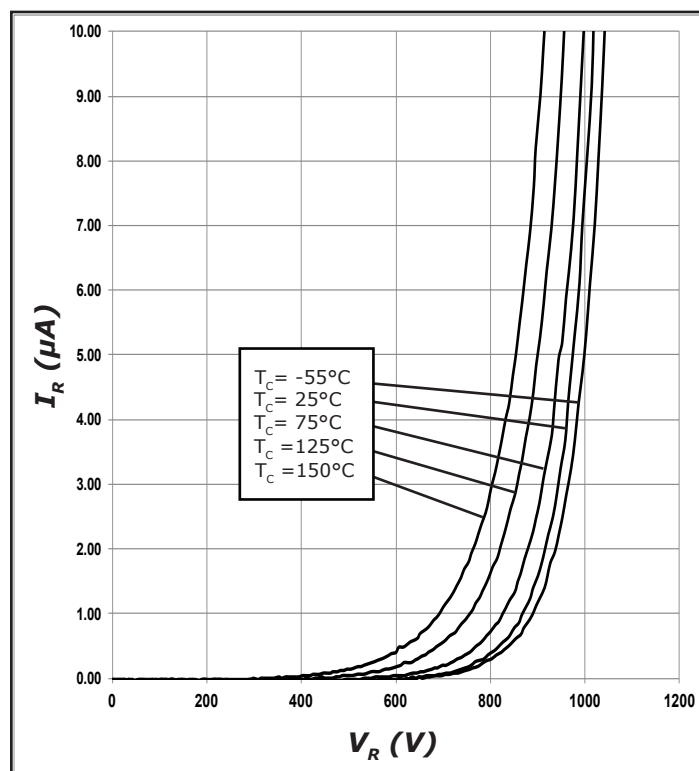


Figure 2. Reverse Characteristics

Typical Performance

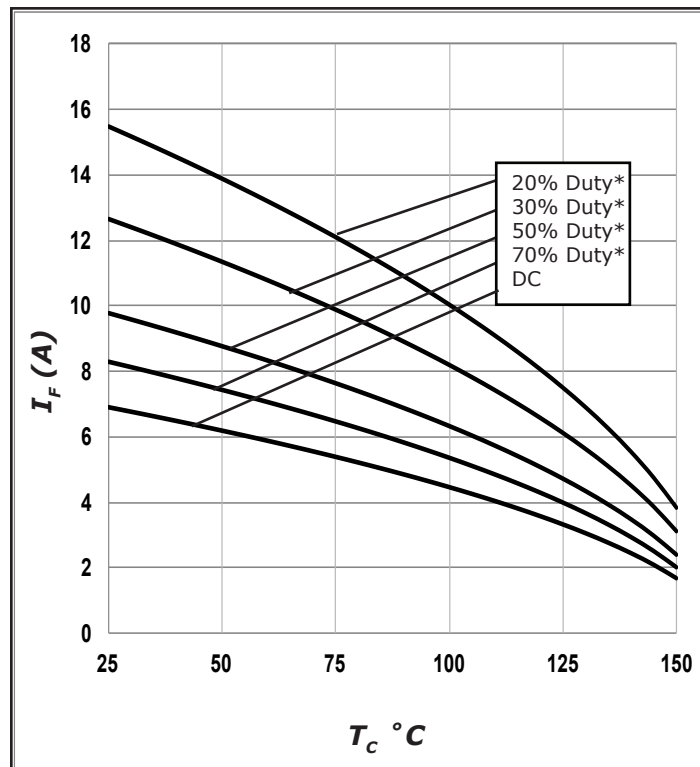


Figure 3. Current Derating

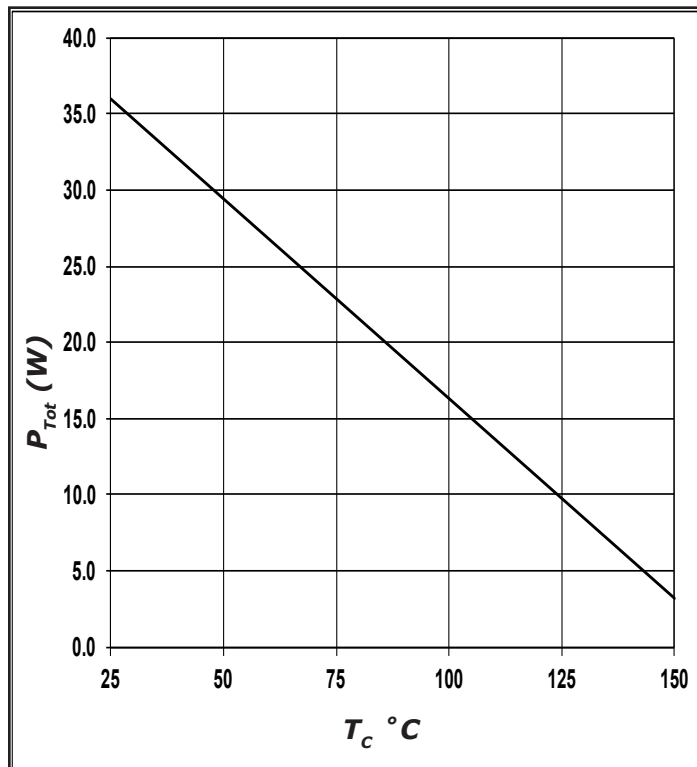


Figure 4. Power Derating

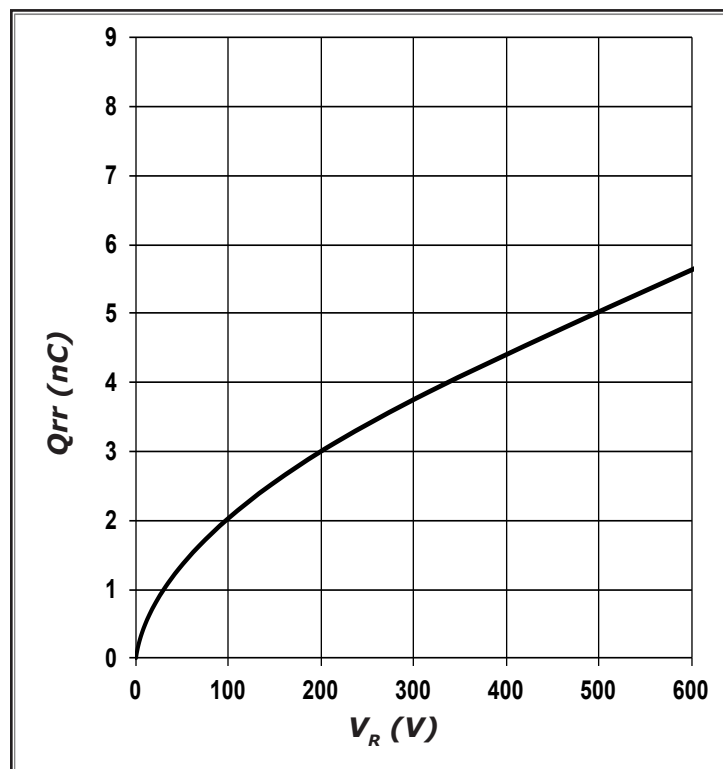


Figure 5. Recovery Charge vs. Reverse Voltage

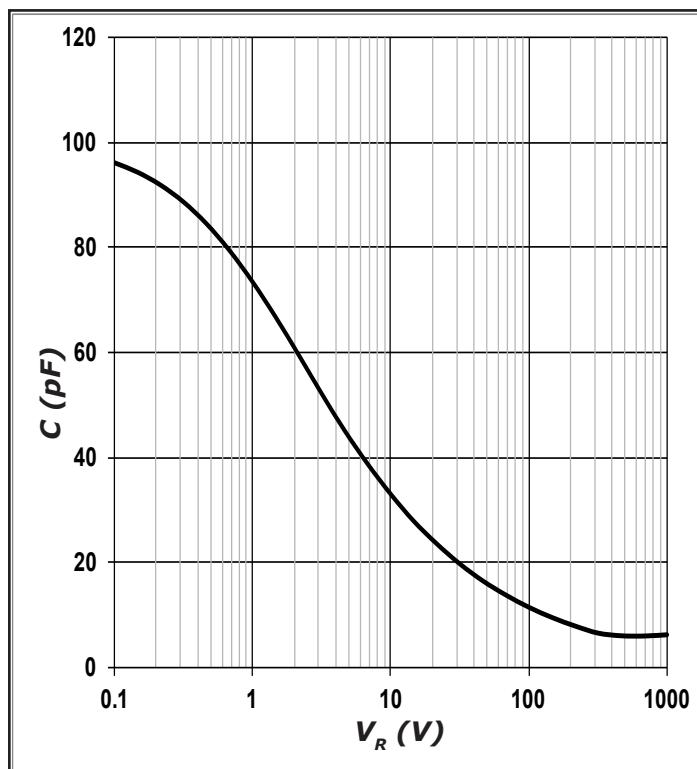


Figure 6. Capacitance vs. Reverse Voltage

Typical Performance

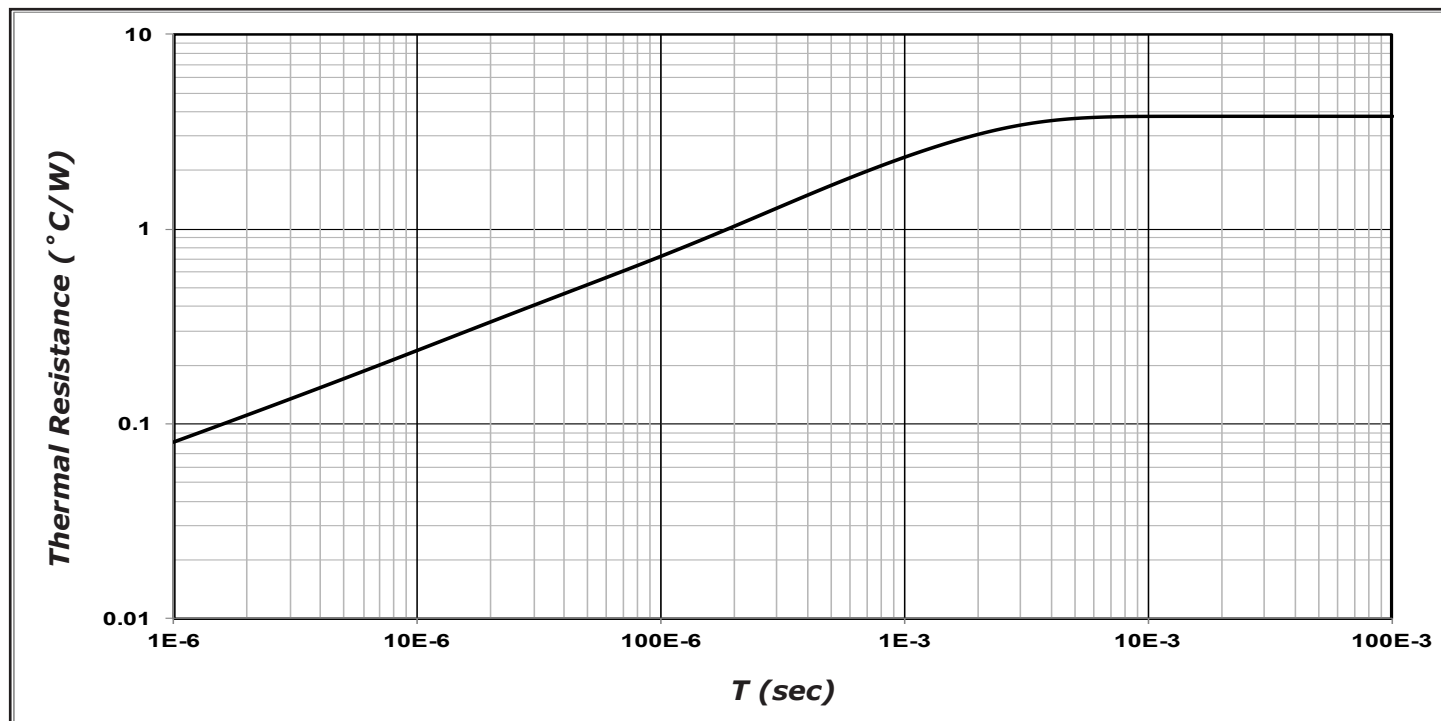
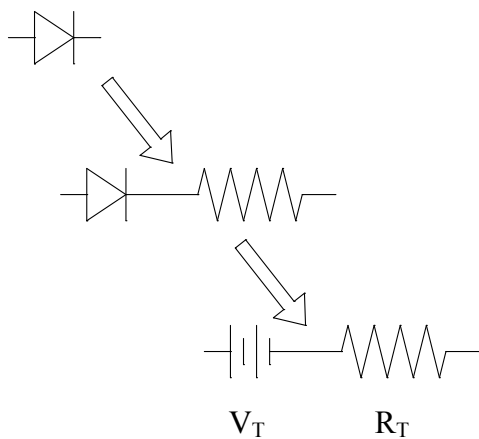


Figure 7. Transient Thermal Impedance

Diode Model



$$V_{f_T} = V_T + I_f \cdot R_T$$

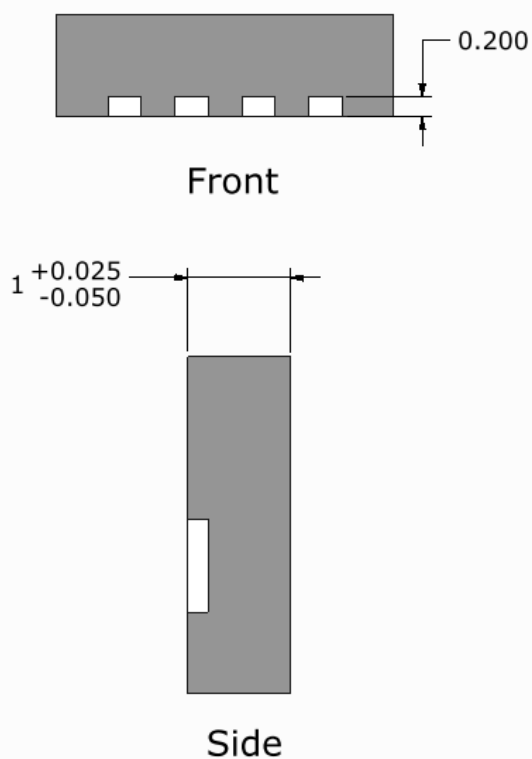
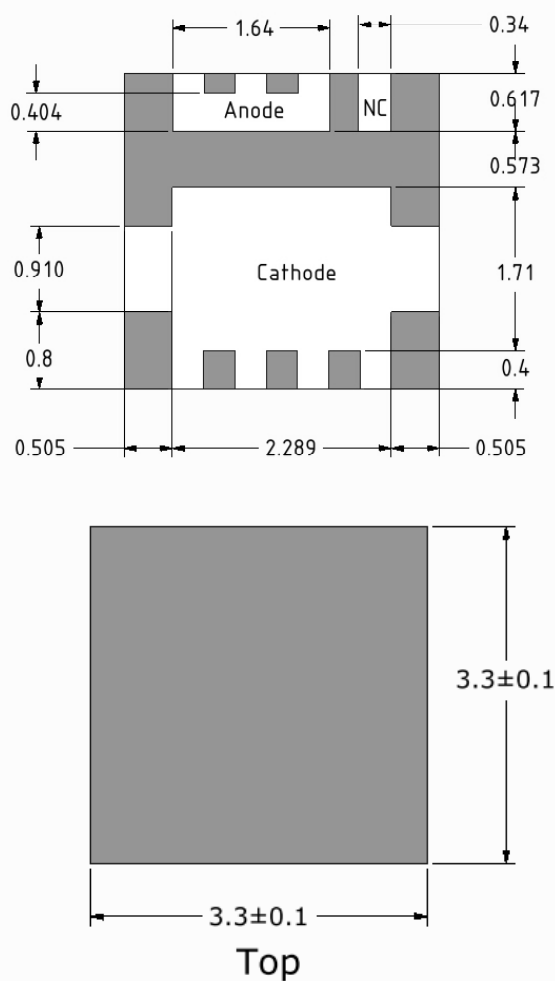
$$V_T = 0.99 + (T_j \cdot -1.5 \cdot 10^{-3})$$

$$R_T = 0.22 + (T_j \cdot 2.6 \cdot 10^{-3})$$

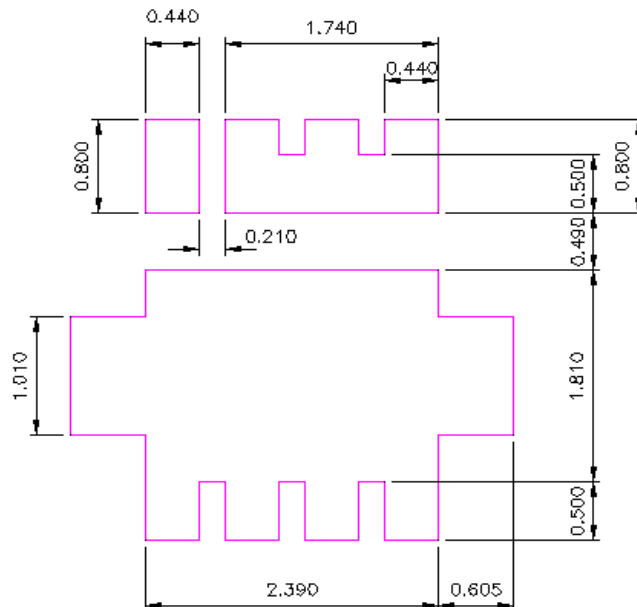
Note: T_j = Diode Junction Temperature In Degrees Celsius

Package Dimensions

Package QFN 3.3



All Dimensions are in mm
Tolerances are 0.05 mm if not specified
NC = No Connect



The 0.050mm extra length and width provides space to accommodate the placement tolerance of the component during pick and place process. The 0.150mm along the perimeter present areas for solder to form fillet along the side metal edges of the package.





Notes

- **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

- **REACH Compliance**

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

- This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, air traffic control systems, or weapons systems.